MMVL3700T1

High Voltage Silicon Pin Diode

These devices are designed primarily for VHF band switching applications but are also suitable for use in general-purpose switching circuits. They are supplied in a cost-effective plastic surface mount package for economical, high-volume consumer and industrial requirements.

Features

- Long Reverse Recovery Time: $t_{rr} = 300 \text{ ns (Typ)}$
- Rugged PIN Structure Coupled with Wirebond Construction for Optimum Reliability
- Low Series Resistance @ 100 MHz:

 $R_S = 0.7 \Omega \text{ (Typ)} @ I_F = 10 \text{ mAdc}$

- Reverse Breakdown Voltage = 200 V (Min)
- Pb-Free Package is Available

MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Continuous Reverse Voltage	V _R	200	Vdc	
Peak Forward Current	IF	20	mAdc	

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR–5 Board, T _A = 25°C (Note 1) Derate above 25°C	P _D	200 1.57	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	635	°C/W
Junction and Storage Temperature	T _J , T _{stg}	150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. FR-4 Minimum Pad



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SILICON PIN SWITCHING DIODE





PLASTIC SOD-323 CASE 477 STYLE 1

MARKING DIAGRAM



4R = Device Code M = Date Code* ■ = Pb-Free Package

(Note: Microdot may be in either location)
*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
MMVL3700T1	SOD-323	3000/Tape & Reel
MMVL3700T1G	SOD-323 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MMVL3700T1

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Breakdown Voltage (I _R = 10 μAdc)	V _{(BR)R}	200	-	-	Vdc
Diode Capacitance (V _R = 20 Vdc, f = 1.0 MHz)	C _T	-	-	1.0	pF
Series Resistance (I _F = 10 mAdc)	R _S	-	0.7	1.0	Ω
Reverse Leakage Current (V _R = 150 Vdc)	I _R	-	-	0.1	μAdc
Reverse Recovery Time $(I_F = I_R = 10 \text{ mAdc})$	t _{rr}	_	300	ı	ns

TYPICAL CHARACTERISTICS

100 40

> 10 4.0

1.0

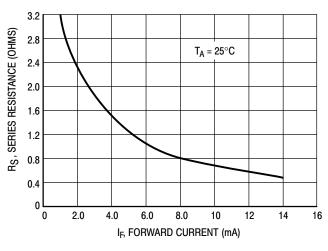
0.4

0.04 0.01

0.004 0.001

-60

I _R , REVERSE CURRENT (μ A)



800 700 600 400 300 0 7A = 25°C T_A = 25°C 100 0 0.7 0.8 0.9 1.0 V_F FORWARD VOLTAGE (VOLTS)

Figure 1. Series Resistance

10 8.0 4.0 4.0 2.0 1.0 0.8 0.6 0.6 0.4 0.2 0.1 0 -10 -20 -30 -40 -50 V_R, REVERSE VOLTAGE (VOLTS)

V_R = 15 Vdc

Figure 2. Forward Voltage

Figure 3. Diode Capacitance

T_A, AMBIENT TEMPERATURE (°C)

Figure 4. Leakage Current

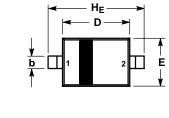
+100

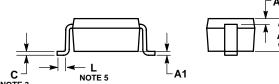
+140

MMVL3700T1

PACKAGE DIMENSIONS

SOD-323 CASE 477-02 ISSUE G





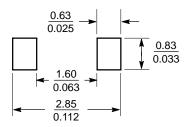
NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
 V14 5M 1982
- Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETERS.
- LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH SOLDER PLATING.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
- DIMENSION L IS MEASURED FROM END OF RADIUS.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.80	0.90	1.00	0.031	0.035	0.040	
A1	0.00	0.05	0.10	0.000	0.002	0.004	
A3	().15 REI	REF 0.006 REF			F	
b	0.25	0.32	0.4	0.010	0.012	0.016	
С	0.089	0.12	0.177	0.003	0.005	0.007	
D	1.60	1.70	1.80	0.062	0.066	0.070	
Е	1.15	1.25	1.35	0.045	0.049	0.053	
L	0.08			0.003			
HE	2.30	2.50	2.70	0.090	0.098	0.105	

STYLE 1: PIN 1. CATHODE 2. ANODE

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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